mail

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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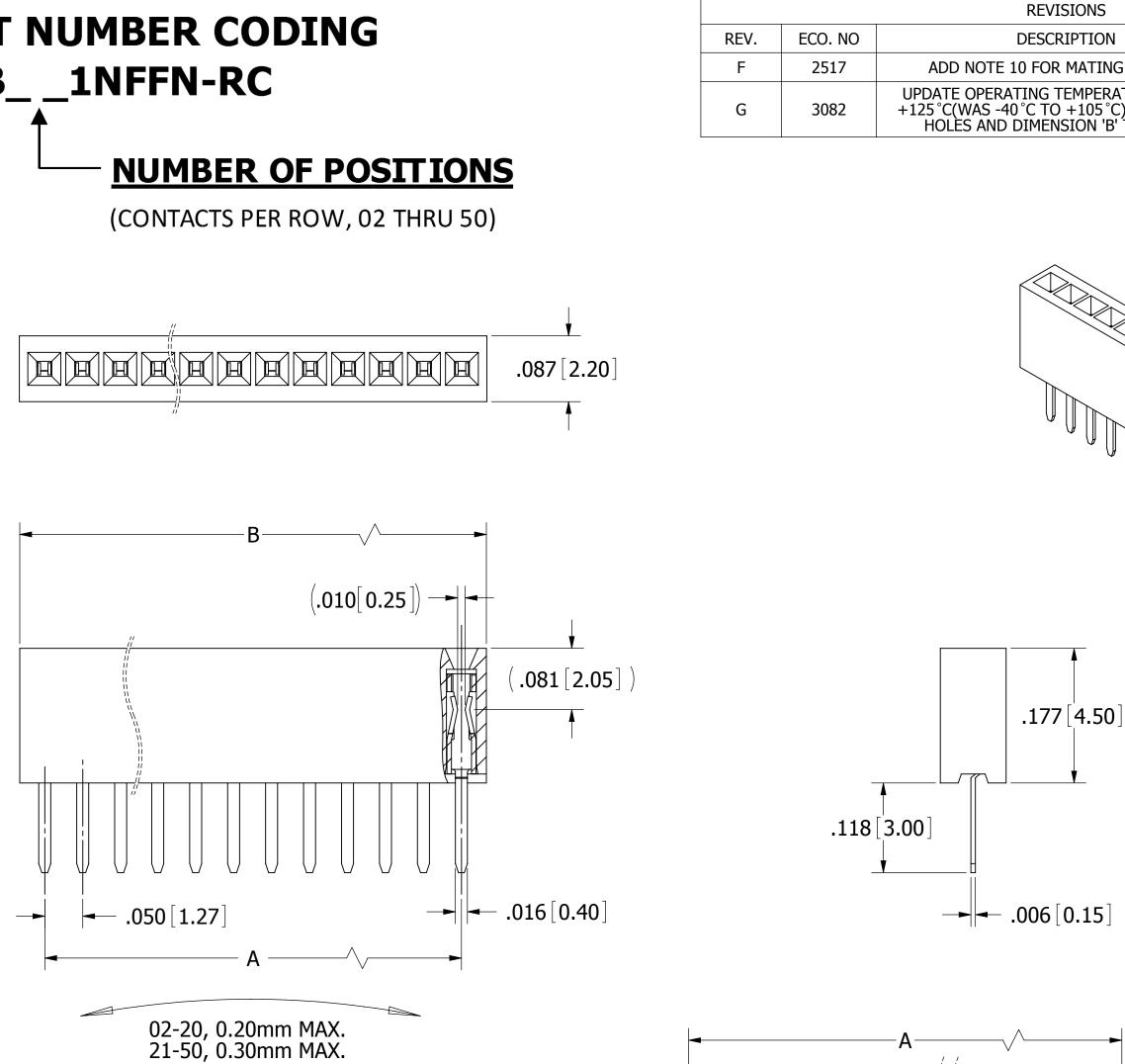
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POSITIONS/	ļ A	4	E	3	
CONTACTS	INCH±.008	MM±0.20	INCH±.008	MM±0.20	
02/02	0.050	1.27	0.116	2.94	
03/03	0.100	2.54	0.166	4.21	LPPB_
04/04	0.150	3.81	0.216	5.48	
05/05	0.200	5.08 6.35	0.266	6.75 8.02	
06/06	0.250	7.62	0.316	9.29	
08/08	0.350	8.89	0.300	10.56	
09/09	0.400	10.16	0.466	11.83	
10/10	0.450	11.43	0.516	13.10	
11/11	0.500	12.70	0.566	14.37	
12/12	0.550	13.97	0.616	15.64	
13/13	0.600	15.24	0.666	16.91	
14/14	0.650	16.51	0.716	18.18	
15/15	0.700	17.78	0.766	19.45	
16/16	0.750	19.05	0.816	20.72	
17/17 18/18	0.800	20.32 21.59	0.866	21.99 23.26	
19/19	0.830	21.39	0.916	23.20	
20/20	0.950	24.13	1.016	25.80	
21/21	1.000	25.40	1.066	27.07	
22/22	1.050	26.67	1.116	28.34	
23/23	1.100	27.94	1.166	29.61	
24/24	1.150	29.21	1.216	30.88	
25/25	1.200	30.48	1.266	32.15	
26/26	1.250	31.75	1.316	33.42	
27/27	1.300	33.02	1.366	34.69	
28/28	1.350	34.29	1.416	35.96	
29/29 30/30	1.400 1.450	35.56 36.83	1.466 1.516	37.23 38.50	
31/31	1.500	38.10	1.566	39.77	
32/32	1.550	39.37	1.616	41.04	
33/33	1.600	40.64	1.666	42.31	
34/34	1.650	41.91	1.716	43.58	
35/35	1.700	43.18	1.766	44.85	
36/36	1.750	44.45	1.816	46.12	
37/37	1.800	45.72	1.866	47.39	
38/38	1.850	46.99	1.916	48.66	
39/39	1.900	48.26	1.966	49.93	
40/40 41/41	1.950 2.000	49.53 50.80	2.016 2.066	51.20 52.47	
42/42	2.000	52.07	2.116	53.74	
43/43	2.100	53.34	2.166	55.01	
44/44	2.150	54.61	2.216	56.28	
45/45	2.200	55.88	2.266	57.55	
46/46	2.250	57.15	2.316	58.82	
47/47	2.300	58.42	2.366	60.09	
48/48	2.350	59.69	2.416	61.36	
49/49	2.400	60.96	2.466	62.63	
50/50	2.450	62.23	2.516	63.90	
*PRO 2. CONT 3. PLATI 4. OPER	CESSING ACT MAT NG: .000 ATING TE	TEMPER ERIAL: P 030"00 MPERAT	ATURE: 20 HOSPHOR 00050" NI URE: -40°	50°C MÁ) BRONZE CKEL UN C TO +12	DERPLATED, GO 25°C
	ACT RESI CTRIC W ENT RATI S WITH S	STANCE: ITHSTAN NG: 1 AN SULLINS	20 MILLI DING: 50 4P 050 [1.27	OHMS M 0 VAC	
*INDICAT		ERATURE			R COMPONENT

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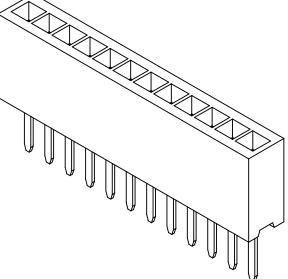
- ONDS
- GOLD FLASH OVERALL
- ALE HEADER SERIES

INSULATOR. HIGHER PROCESSING TEMPERATURES MAY BE USED, PROVIDED HEAT IS APPLIED FROM BACK SIDE OF PCB, AND INSULATOR DOES NOT EXCEED INDICATED TEMPERATURE AND TIME.

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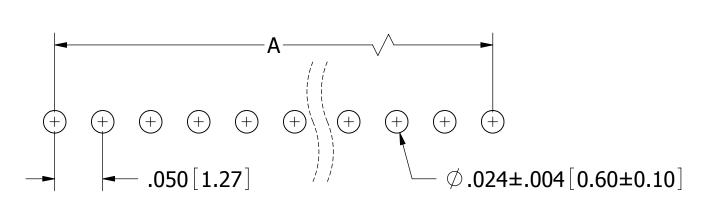
3		2	1					
REVISIONS								
REV.	ECO. NO	DESCRIPTION	DATE	BY				
F	2517	ADD NOTE 10 FOR MATING POST SIZE	2/13/2012	JH				
G	3082	UPDATE OPERATING TEMPERATURE -40 °C TO +125 °C(WAS -40 °C TO +105 °C), P.C.B LAYOUT HOLES AND DIMENSION 'B' TOLERANCE	11/03/2014	LH				



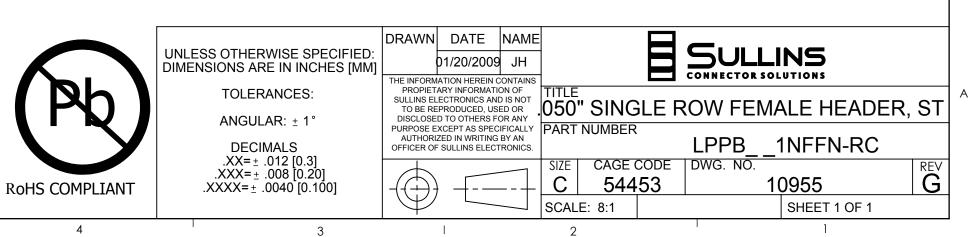
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RECOMMENDED PCB HOLE LAYOUT



FILE NAME: 10955, LPPB__1NFFN-RC